



# PCA9543A 2-Channel I<sup>2</sup>C Bus Switch With Interrupt Logic and Reset

## 1 Features

- 1-of-2 Bidirectional Translating Switches
- I<sup>2</sup>C Bus and SMBus Compatible
- Two Active-Low Interrupt Inputs
- Active-Low Interrupt Output
- Active-Low Reset Input
- Two Address Pins Allowing up to Four PCA9543A Devices on the I<sup>2</sup>C Bus
- Channel Selection Via I<sup>2</sup>C Bus, in Any Combination
- Power-up With All Switch Channels Deselected
- Low R<sub>ON</sub> Switches
- Allows Voltage-Level Translation Between 1.8-V, 2.5-V, 3.3-V, and 5-V Buses
- No Glitch on Power-up
- Supports Hot Insertion
- Low Standby Current
- Operating Power-Supply Voltage Range of 2.3 V to 5.5 V
- 5.5-V Tolerant Inputs
- 0 to 400-kHz Clock Frequency
- Latch-Up Performance Exceeds 100-mA Per JESD78
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 1000-V Charged-Device Model (C101)

## 2 Applications

- Servers
- Routers (Telecom Switching Equipment)
- Factory Automation
- Products With I<sup>2</sup>C Slave Address Conflicts (e.g. Multiple, Identical Temp Sensors)

## 3 Description

The PCA9543A is a dual bidirectional translating switch controlled by the I<sup>2</sup>C bus. The SCL/SDA upstream pair fans out to two downstream pairs, or channels. Either individual SCn/SDn channel or both channels can be selected, determined by the contents of the programmable control register. Two interrupt inputs ( $\overline{\text{INT1}}$ – $\overline{\text{INT0}}$ ), one for each of the downstream pairs, are provided. One interrupt output ( $\overline{\text{INT}}$ ) acts as an AND of the two interrupt inputs.

An active-low reset ( $\overline{\text{RESET}}$ ) input allows the PCA9543A to recover from a situation where one of the downstream I<sup>2</sup>C buses is stuck in a low state. Pulling  $\overline{\text{RESET}}$  low resets the I<sup>2</sup>C state machine and causes both of the channels to be deselected, as does the internal power-on reset function.

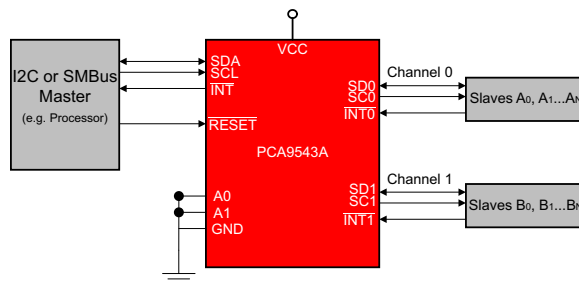
The pass gates of the switches are constructed such that the VCC pin can be used to limit the maximum high voltage, which will be passed by the PCA9543A. This allows the use of different bus voltages on each pair, so that 1.8-V, 2.5-V, or 3.3-V parts can communicate with 5-V parts without any additional protection. External pull-up resistors pull the bus up to the desired voltage level for each channel. All I/O pins are 5.5-V tolerant.

### Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)
PCA9543	TSSOP (14)	5.00 mm × 4.40 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.

## 4 Simplified Application Diagram



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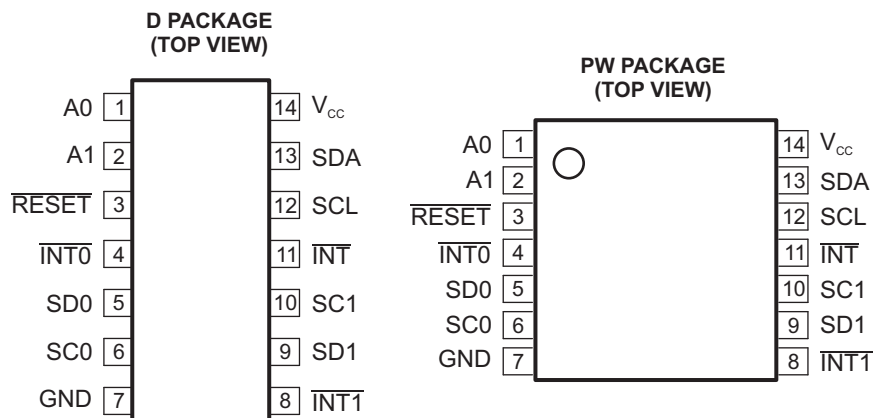
## 5 Revision History

### Changes from Original (September 2007) to Revision A

Page

• Removed Ordering Information table. ....	<b>2</b>
• Added Power-On Reset Errata section. ....	<b>19</b>

## 6 Pin Configuration and Functions



**Pin Functions**

PIN		DESCRIPTION
NAME	D, PW	
A0	1	Address input 0. Connect directly to V <sub>CC</sub> or ground.
A1	2	Address input 1. Connect directly to V <sub>CC</sub> or ground.
RESET	3	Active-low reset input. Connect to V <sub>CC</sub> or V <sub>DPUM</sub> <sup>(1)</sup> through a pull-up resistor, if not used.
INT0	4	Active-low interrupt input 0. Connect to V <sub>DPU0</sub> <sup>(1)</sup> through a pull-up resistor.
SD0	5	Serial data 0. Connect to V <sub>DPU0</sub> <sup>(1)</sup> through a pull-up resistor.
SC0	6	Serial clock 0. Connect to aV <sub>DPU0</sub> <sup>(1)</sup> through a pull-up resistor.
GND	7	Ground
INT1	8	Active-low interrupt input 1. Connect to V <sub>DPU1</sub> <sup>(1)</sup> through a pull-up resistor.
SD1	9	Serial data 1. Connect to V <sub>DPU1</sub> <sup>(1)</sup> through a pull-up resistor.
SC1	10	Serial clock 1. Connect to V <sub>DPU1</sub> <sup>(1)</sup> through a pull-up resistor.
INT	11	Active-low interrupt output. Connect to V <sub>DPUM</sub> <sup>(1)</sup> through a pull-up resistor.
SCL	12	Serial clock line. Connect to V <sub>DPUM</sub> <sup>(1)</sup> through a pull-up resistor.
SDA	13	Serial data line. Connect to V <sub>DPUM</sub> <sup>(1)</sup> through a pull-up resistor.
VCC	14	Supply power

(1) V<sub>DPUX</sub> is the pull-up reference voltage for the associated data line. V<sub>DPUM</sub> is the master I<sup>2</sup>C reference voltage while V<sub>DPU0</sub> and V<sub>DPU1</sub> are the slave channel reference voltages.

## 7 Specifications

### 7.1 Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range	–0.5	7	V
V <sub>I</sub>	Input voltage range <sup>(2)</sup>	–0.5	7	V
I <sub>I</sub>	Input current		±20	mA
I <sub>O</sub>	Output current		±25	mA
	Continuous current through V <sub>CC</sub>		±100	mA
	Continuous current through GND		±100	mA
θ <sub>JA</sub>	Package thermal impedance <sup>(3)</sup>	D package	86	°C/W
		PW package	113	
P <sub>tot</sub>	Total power dissipation		400	mW
T <sub>A</sub>	Operating free-air temperature range	–40	85	°C

- (1) Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The package thermal impedance is calculated in accordance with JESD 51-7.

### 7.2 Handling Ratings

			MIN	MAX	UNIT
T <sub>stg</sub>	Storage temperature range		–60	150	°C
V <sub>(ESD)</sub>	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>	0	2000	V
		Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup>	0	1000	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions<sup>(1)</sup>

				MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage			2.3	5.5	V
V <sub>IH</sub>	High-level input voltage	SCL, SDA		0.7 × V <sub>CC</sub>	6	V
		A1, A0, $\overline{\text{INT1}}$ , $\overline{\text{INT0}}$ , $\overline{\text{RESET}}$	V <sub>CC</sub> = 2.3 V to 3.6 V	0.7 × V <sub>CC</sub>	V <sub>CC</sub> + 0.5	
			V <sub>CC</sub> = 3.6 V to 4.5 V	0.7 × V <sub>CC</sub>	V <sub>CC</sub> + 0.5	
			V <sub>CC</sub> = 4.5 V to 5.5 V	0.7 × V <sub>CC</sub>	V <sub>CC</sub> + 0.5	
V <sub>IL</sub>	Low-level input voltage	SCL, SDA		−0.5	0.3 × V <sub>CC</sub>	V
		A1, A0, $\overline{\text{INT1}}$ , $\overline{\text{INT0}}$ , $\overline{\text{RESET}}$		−0.5	0.3 × V <sub>CC</sub>	
T <sub>A</sub>	Operating free-air temperature			−40	85	°C

- (1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## 7.4 Thermal Information

THERMAL METRIC <sup>(1)</sup>		PCA9543A	UNIT
		PW	
		14 PINS	
R <sub>θJA</sub>	Junction-to-ambient thermal resistance	130.9	°C/W
R <sub>θJCTop</sub>	Junction-to-case (top) thermal resistance	59.2	
R <sub>θJB</sub>	Junction-to-board thermal resistance	72.7	
ψ <sub>JT</sub>	Junction-to-top characterization parameter	10.5	
ψ <sub>JB</sub>	Junction-to-board characterization parameter	72.1	

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

## 7.5 Electrical Characteristics<sup>(1)</sup>

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V <sub>CC</sub>	MIN	TYP	MAX	UNIT
V <sub>POR</sub>	Power-on reset voltage	No load: V <sub>I</sub> = V <sub>CC</sub> or GND <sup>(2)</sup>	V <sub>POR</sub>	1.6	2.1		V
V <sub>pass</sub>	Switch output voltage	V <sub>SWin</sub> = V <sub>CC</sub> , I <sub>SWout</sub> = –100 μA	5 V	3.6			V
			4.5 V to 5.5 V	2.6		4.5	
			3.3 V	1.9			
			3 V to 3.6 V	1.6		2.8	
			2.5 V	1.5			
			2.3 V to 2.7 V	1.1		2	
I <sub>OH</sub>	$\overline{\text{INT}}$	V <sub>O</sub> = V <sub>CC</sub>	2.3 V to 5.5 V			100	μA
I <sub>OL</sub>	SDA	V <sub>OL</sub> = 0.4 V	2.3 V to 5.5 V	3	7		mA
		V <sub>OL</sub> = 0.6 V		6	10		
	$\overline{\text{INT}}$	V <sub>OL</sub> = 0.4 V		3			
I <sub>I</sub>	SCL, SDA	V <sub>I</sub> = V <sub>CC</sub> or GND	2.3 V to 5.5 V	–1		1	μA
	SC1–SC0, SD1–SD0	V <sub>I</sub> = V <sub>CC</sub> or GND	2.3 V to 3.6 V	–1		1	
			4.5 V to 5.5 V	–1		100	
	A1, A0	V <sub>I</sub> = V <sub>CC</sub> or GND	2.3 V to 3.6 V	–1		1	
			4.5 V to 5.5 V	–1		50	
	$\overline{\text{INT1}}\text{--}\overline{\text{INT0}}$	V <sub>I</sub> = V <sub>CC</sub> or GND	2.3 V to 3.6 V	–1		1	
			4.5 V to 5.5 V	–1		50	
	$\overline{\text{RESET}}$	V <sub>I</sub> = V <sub>CC</sub> or GND	2.3 V to 3.6 V	–1		1	
			4.5 V to 5.5 V	–1		50	
I <sub>CC</sub>	Operating mode	f <sub>SCL</sub> = 100 kHz	5.5 V		17	50	μA
			3.6 V		6	20	
			2.7 V		3	16	
	Standby mode	Low inputs	5.5 V		0.3	1	
			3.6 V		0.1	1	
			2.7 V		0.1	1	
		High inputs	5.5 V		0.3	1	
			3.6 V		0.1	1	
			2.7 V		0.1	1	

(1) For operation between published voltage ranges, refer to the worst-case parameter in both ranges.

(2) To reset the part, either RESET must be low or V<sub>CC</sub> must be lowered to 0.2 V.

## Electrical Characteristics<sup>(1)</sup> (continued)

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS	V <sub>CC</sub>	MIN	TYP	MAX	UNIT
ΔI <sub>CC</sub>	Supply-current change	$\overline{\text{INT1}}\text{--}\overline{\text{INT0}}$	One $\overline{\text{INT1}}\text{--}\overline{\text{INT0}}$ input at 0.6 V, Other inputs at V <sub>CC</sub> or GND	2.3 V to 5.5 V		8	20	μA
			One $\overline{\text{INT1}}\text{--}\overline{\text{INT0}}$ input at V <sub>CC</sub> – 0.6 V, Other inputs at V <sub>CC</sub> or GND			8	20	
		SCL, SDA	SCL or SDA input at 0.6 V, Other inputs at V <sub>CC</sub> or GND			8	20	
			SCL or SDA input at V <sub>CC</sub> – 0.6 V, Other inputs at V <sub>CC</sub> or GND			8	20	
C <sub>i</sub>	A1, A0		V <sub>I</sub> = V <sub>CC</sub> or GND	2.3 V to 3.6 V		4	5	pF
				4.5 V to 5.5 V		4	5	
	$\overline{\text{INT1}}\text{--}\overline{\text{INT0}}$		V <sub>I</sub> = V <sub>CC</sub> or GND	2.3 V to 3.6 V		4	6	
				4.5 V to 5.5 V		4	6	
	$\overline{\text{RESET}}$		V <sub>I</sub> = V <sub>CC</sub> or GND	2.3 V to 3.6 V		4	5	
				4.5 V to 5.5 V		4	5	
	SCL		V <sub>I</sub> = V <sub>CC</sub> or GND	2.3 V to 5.5 V		9	12	
C <sub>i o(OFF)</sub> <sup>(3)</sup>	SDA	V <sub>I</sub> = V <sub>CC</sub> or GND, Switch OFF	2.3 V to 5.5 V		11	13	pF	
	SC1–SC0, SD1–SD0				6	8		
r <sub>on</sub>	Switch on-state resistance		V <sub>O</sub> = 0.4 V, I <sub>O</sub> = 15 mA	4.5 V to 5.5 V	4	9	20	Ω
				3 V to 3.6 V	5	11	25	
			V <sub>O</sub> = 0.4 V, I <sub>O</sub> = 10 mA	2.3 V to 2.7 V	7	16	50	

(3) C<sub>io(ON)</sub> depends on the device capacitance and load that is downstream from the device.

## 7.6 I<sup>2</sup>C Interface Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

			STANDARD MODE I <sup>2</sup> C BUS		FAST MODE I <sup>2</sup> C BUS		UNIT
			MIN	MAX	MIN	MAX	
f <sub>scl</sub>	I <sup>2</sup> C clock frequency		0	100	0	400	kHz
t <sub>sch</sub>	I <sup>2</sup> C clock high time		4		0.6		$\mu s$
t <sub>scl</sub>	I <sup>2</sup> C clock low time		4.7		1.3		$\mu s$
t <sub>sp</sub>	I <sup>2</sup> C spike time			50		50	ns
t <sub>sds</sub>	I <sup>2</sup> C serial-data setup time		250		100		ns
t <sub>sdh</sub>	I <sup>2</sup> C serial-data hold time		0 <sup>(1)</sup>		0 <sup>(1)</sup>		$\mu s$
t <sub>icr</sub>	I <sup>2</sup> C input rise time			1000	20 + 0.1C <sub>b</sub> <sup>(2)</sup>	300	ns
t <sub>icf</sub>	I <sup>2</sup> C input fall time			300	20 + 0.1C <sub>b</sub> <sup>(2)</sup>	300	ns
t <sub>ocf</sub>	I <sup>2</sup> C output fall time	10-pF to 400-pF bus		300	20 + 0.1C <sub>b</sub> <sup>(2)</sup>	300	ns
t <sub>buf</sub>	I <sup>2</sup> C bus free time between stop and start		4.7		1.3		$\mu s$
t <sub>sts</sub>	I <sup>2</sup> C start or repeated start condition setup		4.7		0.6		$\mu s$
t <sub>sth</sub>	I <sup>2</sup> C start or repeated start condition hold		4		0.6		$\mu s$
t <sub>sps</sub>	I <sup>2</sup> C stop condition setup		4		0.6		$\mu s$
t <sub>vdL(Data)</sub>	Valid-data time (high to low) <sup>(3)</sup>	SCL low to SDA output low valid		1		1	$\mu s$
t <sub>vdH(Data)</sub>	Valid-data time (low to high) <sup>(3)</sup>	SCL low to SDA output high valid		0.6		0.6	$\mu s$
t <sub>vd(ack)</sub>	Valid-data time of ACK condition	ACK signal from SCL low to SDA output low		1		1	$\mu s$
C <sub>b</sub>	I <sup>2</sup> C bus capacitive load			400		400	pF

(1) A device internally must provide a hold time of at least 300 ns for the SDA signal (referred to as the V<sub>IH</sub> min of the SCL signal), in order to bridge the undefined region of the falling edge of SCL.

(2) C<sub>b</sub> = total bus capacitance of one bus line in pF

(3) Data taken using a 1-k $\Omega$  pull-up resistor and 50-pF load (see Figure 1)

## 7.7 Switching Characteristics

over recommended operating free-air temperature range,  $C_L \leq 100$  pF (unless otherwise noted) (see [Figure 3](#))

PARAMETER		FROM (INPUT)	TO (OUTPUT)	MIN	MAX	UNIT
$t_{pd}^{(1)}$ Propagation delay time	$R_{ON} = 20\ \Omega$ , $C_L = 15$ pF	SDA or SCL	SDn or SCn		0.3	ns
	$R_{ON} = 20\ \Omega$ , $C_L = 50$ pF				1	
$t_{iv}$ Interrupt valid time <sup>(2)</sup>		$\overline{INTn}$	$\overline{INT}$		4	$\mu$ s
$t_{ir}$ Interrupt reset delay time <sup>(2)</sup>		$\overline{INTn}$	$\overline{INT}$		2	$\mu$ s

(1) The propagation delay is the calculated RC time constant of the typical ON-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

(2) Data taken using a 4.7-k $\Omega$  pull-up resistor and 100-pF load (see [Figure 3](#))

## 7.8 Interrupt and Reset Timing Requirements

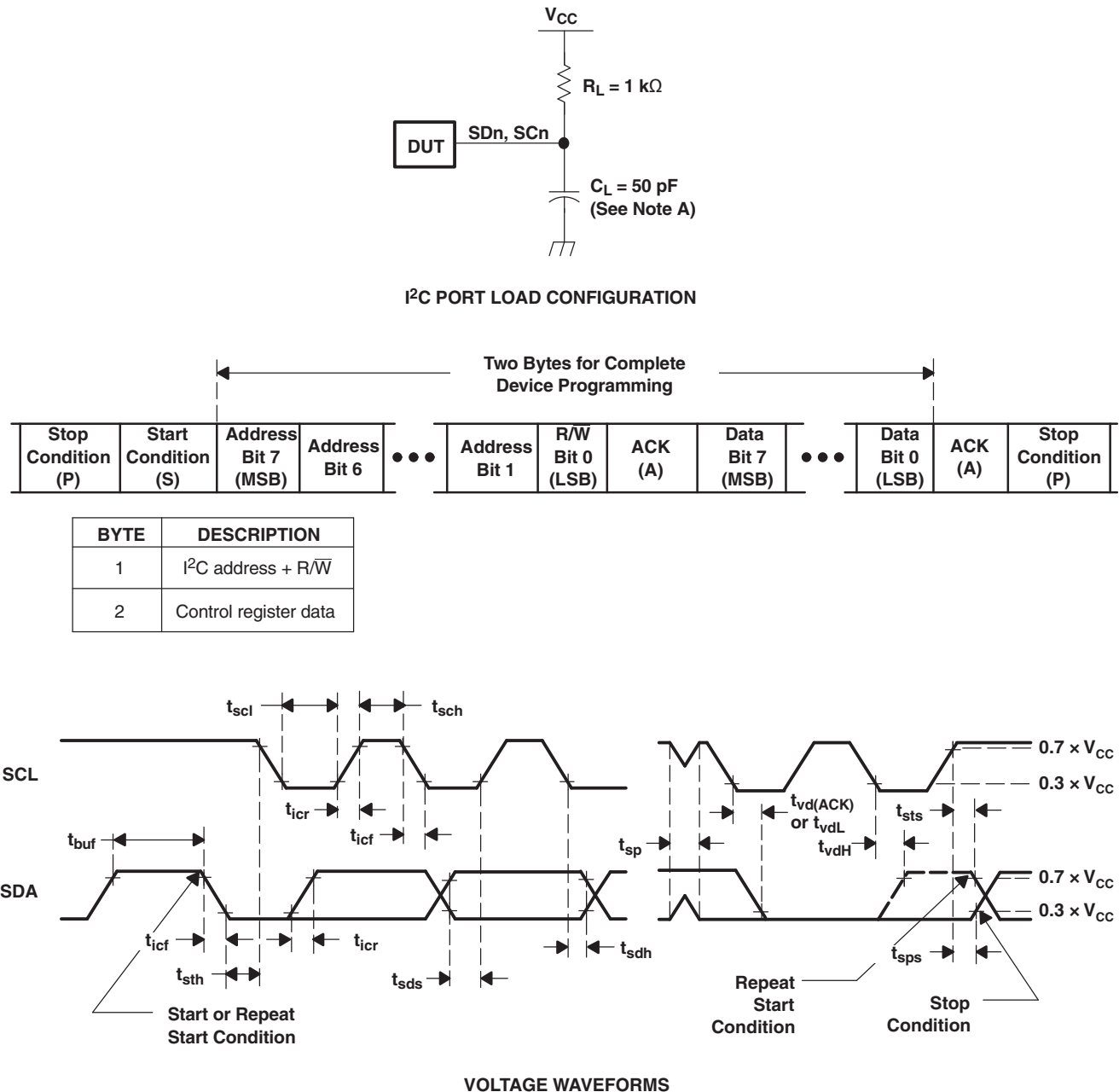
over recommended operating free-air temperature range (unless otherwise noted) (see [Figure 3](#))

PARAMETER		MIN	MAX	UNIT
$t_{PWRL}$	Required low-level pulse duration of $\overline{INTn}$ inputs <sup>(1)</sup>	1		$\mu$ s
$t_{PWRH}$	Required high-level pulse duration of $\overline{INTn}$ inputs <sup>(1)</sup>	0.5		$\mu$ s
$t_{WL}$	Pulse duration, $\overline{RESET}$ low	4		ns
$t_{rst}^{(2)}$	$\overline{RESET}$ time (SDA clear)		500	ns
$t_{REC}$	Recovery time from $\overline{RESET}$ to start	0		ns

(1) The device has interrupt input rejection circuitry for pulses less than the listed minimum.

(2)  $t_{rst}$  is the propagation delay measured from the time the  $\overline{RESET}$  pin is first asserted low to the time the SDA pin is asserted high, signaling a stop condition. It must be a minimum of  $t_{WL}$ .

## 8 Parameter Measurement Information



- $C_L$  includes probe and jig capacitance.
- All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r/t_f = 30\text{ ns}$ .
- The outputs are measured one at a time, with one transition per measurement.

**Figure 1. I<sup>2</sup>C Interface Load Circuit, Byte Descriptions, and Voltage Waveforms**

## Parameter Measurement Information (continued)

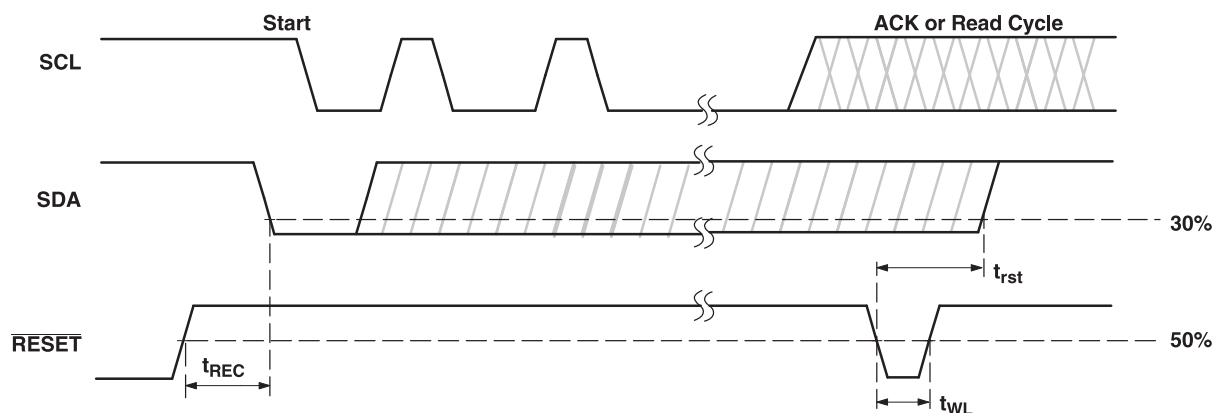
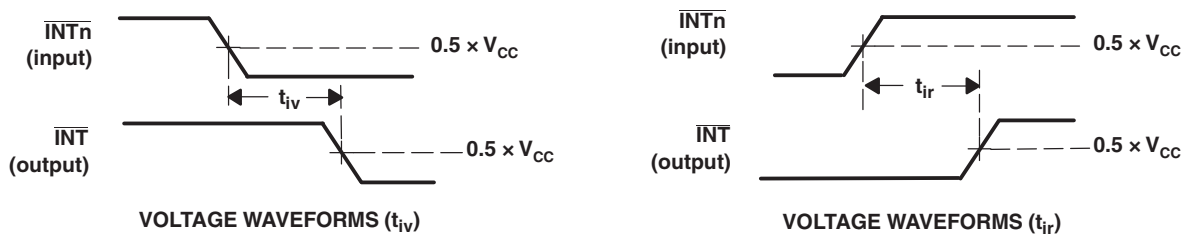
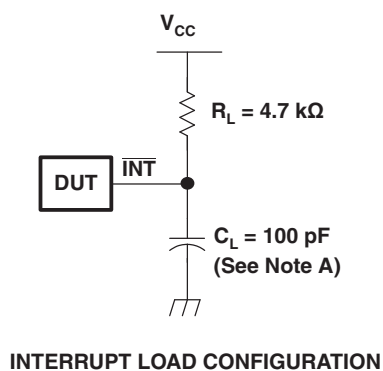


Figure 2. Reset Timing



- A.  $C_L$  includes probe and jig capacitance.
- B. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r/t_f = 30\text{ ns}$ .

Figure 3. Interrupt Load Circuit and Voltage Waveforms

## 9 Detailed Description

### 9.1 Overview

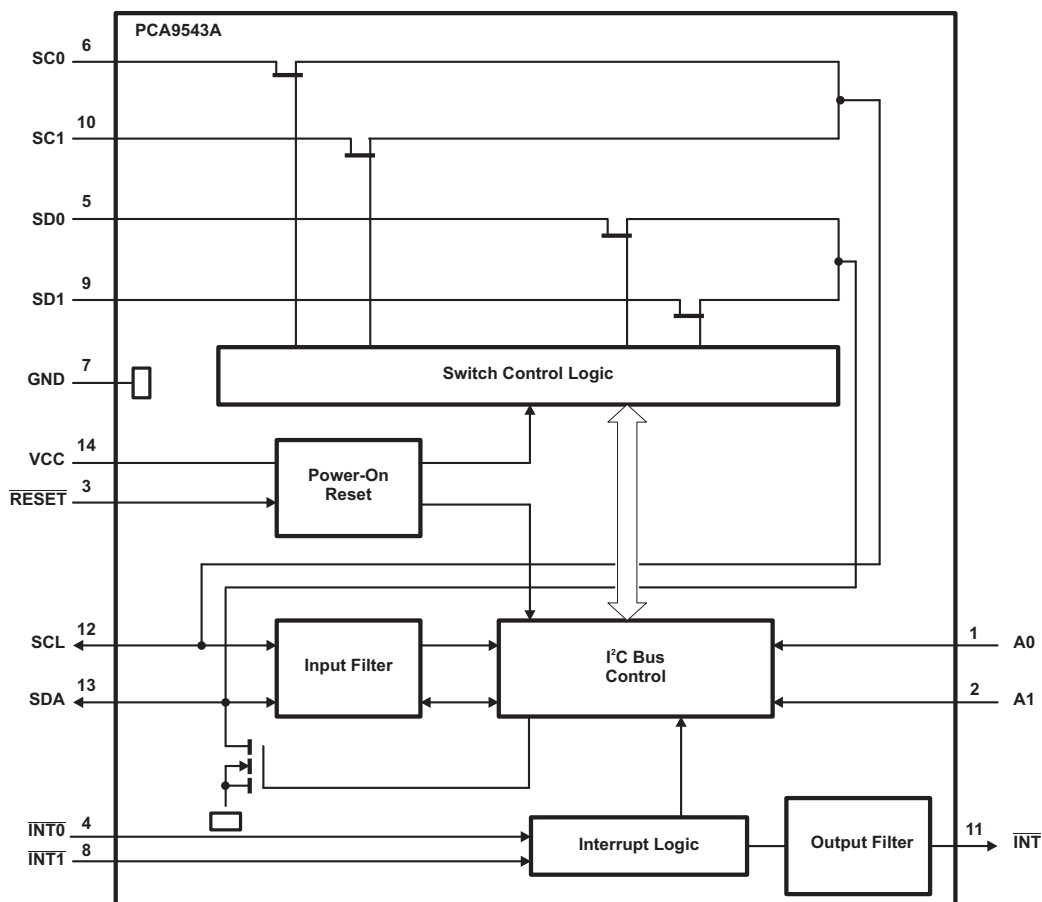
The PCA9543A is a 2-channel, bidirectional translating I<sup>2</sup>C switch. The master SCL/SDA signal pair is directed to two channels of slave devices, SC0/SD0-SC1/SD1. Either individual downstream channel can be selected as well as both channels. The PCA9543A also supports interrupt signals in order for the master to detect an interrupt on the  $\overline{\text{INT}}$  output pin that can result from any of the slave devices connected to the INT1-INT0 input pins.

The device offers an active-low  $\overline{\text{RESET}}$  input which resets the state machine and allows the PCA9543A to recover should one of the downstream I<sup>2</sup>C buses get stuck in a low state. The state machine of the device can also be reset by cycling the power supply, V<sub>CC</sub>, also known as a power-on reset (POR). Either using the  $\overline{\text{RESET}}$  function or causing a POR will cause both channels to be deselected.

The connections of the I<sup>2</sup>C data path are controlled by the same I<sup>2</sup>C master device that is switched to communicate with multiple I<sup>2</sup>C slaves. After the successful acknowledgment of the slave address (hardware selectable by A0 and A1 pins), a single 8-bit control register is written to or read from to determine the selected channels and state of the interrupts.

The PCA9543A may also be used for voltage translation, allowing the use of different bus voltages on each SCn/SDn pair such that 1.8-V, 2.5-V, or 3.3-V parts can communicate with 5-V parts. This is achieved by using external pull-up resistors to pull the bus up to the desired voltage for the master and each slave channel.

### 9.2 Functional Block Diagram



## 9.3 Feature Description

The PCA9543A is a dual channel bidirectional translating switch for I<sup>2</sup>C buses that supports Standard-Mode (100 kHz) and Fast-Mode (400 kHz) operation. The PCA9543A features I<sup>2</sup>C control using a single 8-bit control register in which bits 1 and 0 control the enabling and disabling of the two switch channels of I<sup>2</sup>C data flow. The PCA9543A also supports interrupt signals for each slave channel and this data is held in bits 5 and 4 of the control register. Depending on the application, voltage translation of the I<sup>2</sup>C bus can also be achieved using the PCA9543A to allow 1.8-V, 2.5-V, or 3.3-V parts to communicate with 5-V parts. Additionally, in the event that communication on the I<sup>2</sup>C bus enters a fault state, the PCA9543A can be reset to resume normal operation using the RESET pin feature or by a power-on reset which results from cycling power to the device.

## 9.4 Device Functional Modes

### 9.4.1 RESET Input

The RESET input can be used to recover the PCA9543A from a bus-fault condition. The registers and the I<sup>2</sup>C state machine within this device initialize to their default states if this signal is asserted low for a minimum of  $t_{WL}$ . Both channels also are deselected in this case. RESET must be connected to V<sub>CC</sub> through a pull-up resistor.

### 9.4.2 Power-On Reset

When power is applied to V<sub>CC</sub>, an internal power-on reset holds the PCA9543A in a reset condition until V<sub>CC</sub> has reached V<sub>PORR</sub>. At this point, the reset condition is released and the PCA9543A registers and I<sup>2</sup>C state machine are initialized to their default states, all zeroes, causing all the channels to be deselected. Thereafter, V<sub>CC</sub> must be lowered below V<sub>PORF</sub> to reset the device.

Refer to the [Power-On Reset Errata](#) section.

## 9.5 Programming

### 9.5.1 I<sup>2</sup>C Interface

The I<sup>2</sup>C bus is for two-way, two-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor when connected to the output stages of a device. Data transfer may be initiated only when the bus is not busy.

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the high period of the clock pulse as changes in the data line at this time is interpreted as control signals (see [Figure 4](#)).

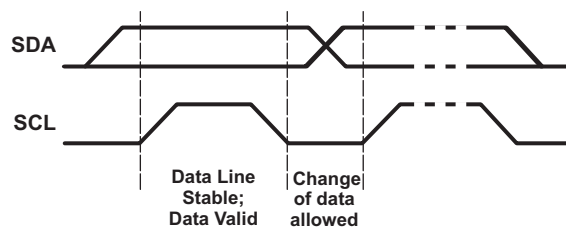


Figure 4. Bit Transfer

Both data and clock lines remain high when the bus is not busy. A high-to-low transition of the data line while the clock is high is defined as the start condition (S). A low-to-high transition of the data line while the clock is high is defined as the stop condition (P) (see [Figure 5](#)).

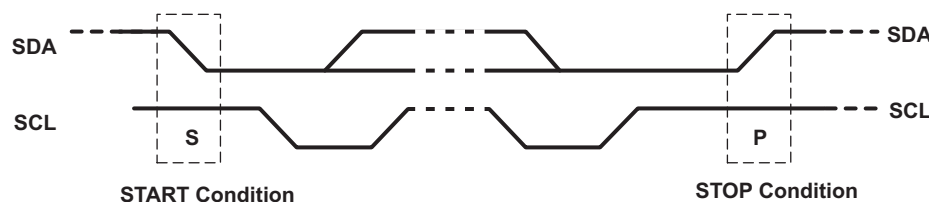
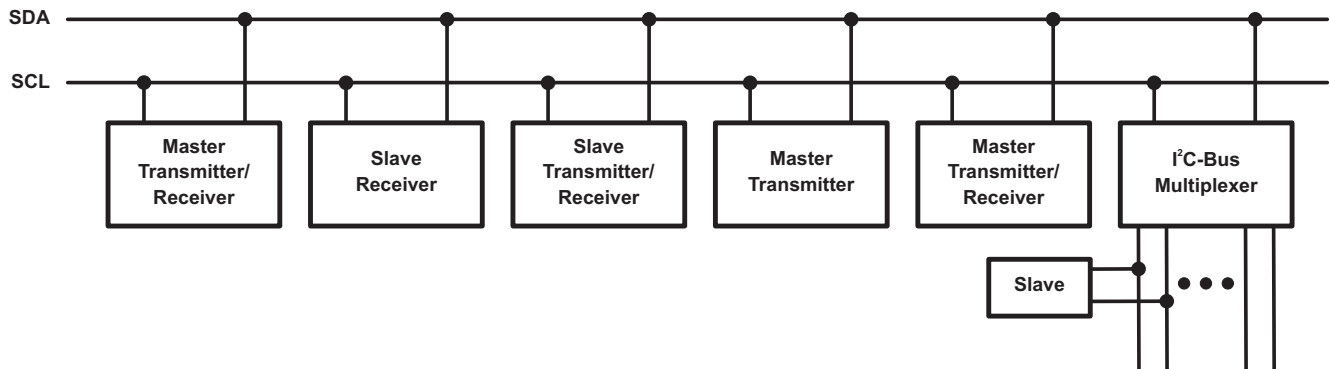


Figure 5. Definition of Start and Stop Conditions

## Programming (continued)

A device generating a message is a transmitter; a device receiving a message is the receiver. The device that controls the message is the master and the devices that are controlled by the master are the slaves (see [Figure 6](#)).

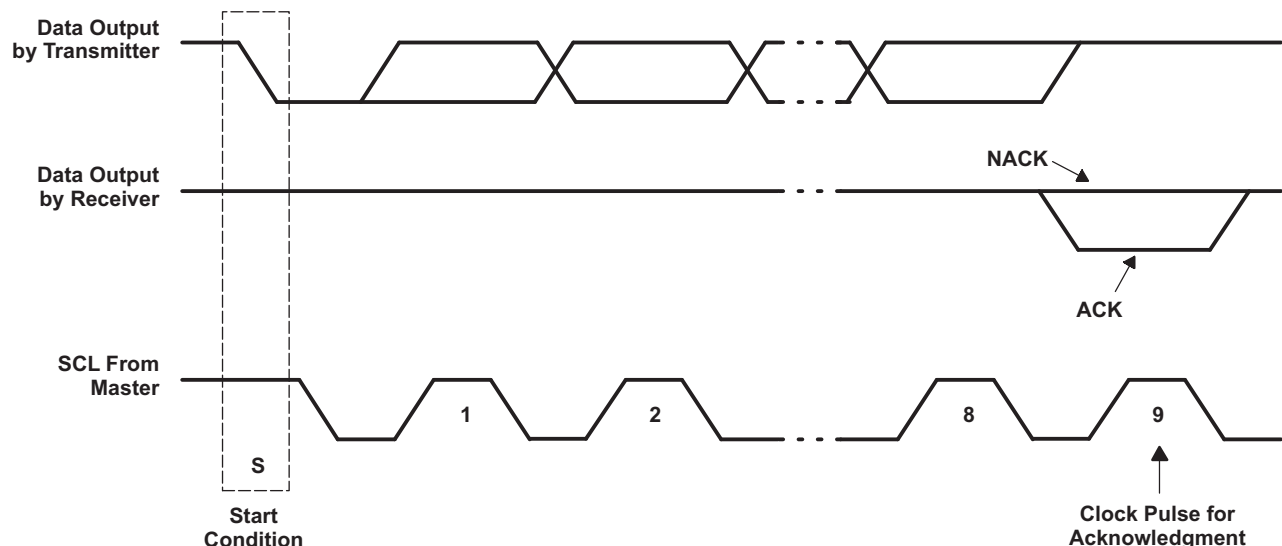


**Figure 6. System Configuration**

The number of data bytes transferred between the start and the stop conditions from transmitter to receiver is not limited. Each byte of eight bits is followed by one acknowledge (ACK) bit. The transmitter must release the SDA line before the receiver can send an ACK bit.

When a slave receiver is addressed, it must generate an ACK after the reception of each byte. Also, a master must generate an ACK after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges must pull down the SDA line during the ACK clock pulse, so that the SDA line is stable low during the high pulse of the ACK-related clock period (see [Figure 7](#)). Setup and hold times must be taken into account.

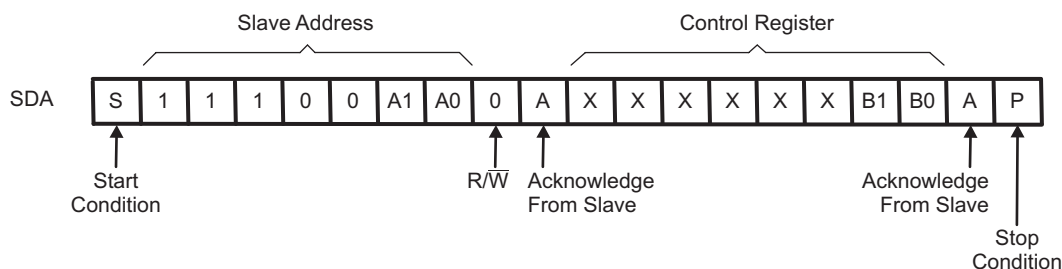
A master receiver must signal an end of data to the transmitter by not generating an acknowledge (NACK) after the last byte has been clocked out of the slave. This is done by the master receiver by holding the SDA line high. In this event, the transmitter must release the data line to enable the master to generate a stop condition.



**Figure 7. Acknowledgment on I<sup>2</sup>C Bus**

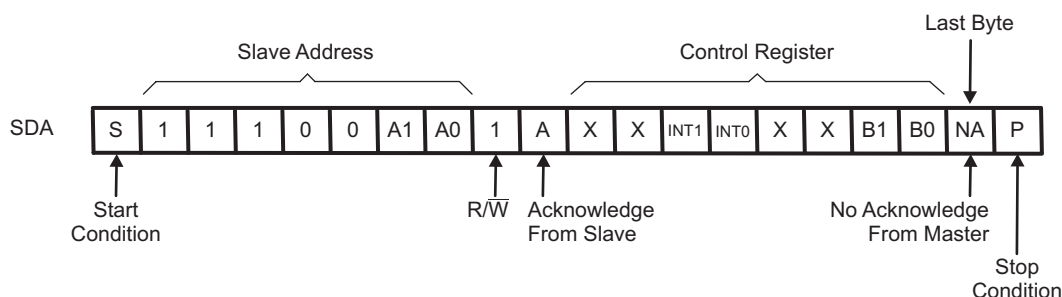
Data is transmitted to the PCA9543A control register using the write mode shown in [Figure 8](#).

## Programming (continued)



**Figure 8. Write Control Register**

Data is read from the PCA9543A control register using the read mode shown in [Figure 9](#).

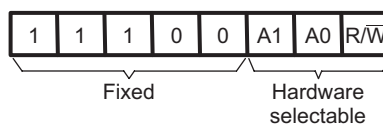


**Figure 9. Read Control Register**

## 9.6 Control Register

### 9.6.1 Device Address

Following a start condition, the bus master must output the address of the slave it is accessing. The address of the PCA9543A is shown in [Figure 10](#). To conserve power, no internal pull-up resistors are incorporated on the hardware-selectable address pins and they must be pulled high or low.



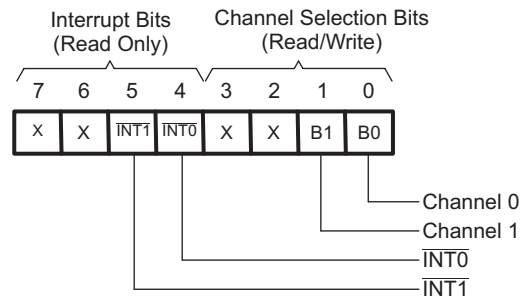
**Figure 10. Slave Address PCA9543A**

The last bit of the slave address defines the operation to be performed. When set to a logic 1, a read is selected, while a logic 0 selects a write operation.

### 9.6.2 Control Register Description

Following the successful acknowledgment of the slave address, the bus master sends a byte to the PCA9543A, which is stored in the control register (see [Figure 11](#)). If multiple bytes are received by the PCA9543A, it saves the last byte received. This register can be written and read via the I<sup>2</sup>C bus.

## Control Register (continued)



**Figure 11. Control Register**

### 9.6.3 Control Register Definition

One or both SCn/SDn downstream pairs, or channels, are selected by the contents of the control register (see [Table 1](#)). After the PCA9543A has been addressed, the control register is written. The two LSBs of the control byte are used to determine which channel or channels are to be selected. When a channel is selected, the channel becomes active after a stop condition has been placed on the I<sup>2</sup>C bus. This ensures that all SCn/SDn lines are in a high state when the channel is made active, so that no false conditions are generated at the time of connection. A stop condition must occur always right after the acknowledge cycle.

**Table 1. Control Register Write (Channel Selection), Control Register Read (Channel Status)<sup>(1)</sup>**

D7	D6	$\overline{\text{INT1}}$	$\overline{\text{INT0}}$	D3	D2	B1	B0	COMMAND
X	X	X	X	X	X	X	0	Channel 0 disabled
							1	Channel 0 enabled
X	X	X	X	X	X	0	X	Channel 1 disabled
						1		Channel 1 enabled
0	0	0	0	0	0	0	0	No channel selected; power-up/reset default state

(1) Channel 0 and channel 1 can be enabled at the same time. Care should be taken not to exceed the maximum bus capacitance.

### 9.6.4 Interrupt Handling

The PCA9543A provides two interrupt inputs (one for each channel) and one open-drain interrupt output (see [Table 2](#)). When an interrupt is generated by any device, it is detected by the PCA9543A and the interrupt output is driven low. The channel does not need to be active for detection of the interrupt. A bit also is set in the control register.

Bit 4 and Bit 5 of the control register correspond to the  $\overline{\text{INT0}}$  and  $\overline{\text{INT1}}$  inputs of the PCA9543A, respectively. Therefore, if an interrupt is generated by any device connected to channel 1, the state of the interrupt inputs is loaded into the control register when a read is accomplished. Likewise, an interrupt on any device connected to channel 0 would cause bit 4 of the control register to be set on the read. The master then can address the PCA9543A and read the contents of the control register to determine which channel contains the device generating the interrupt. The master then can reconfigure the PCA9543A to select this channel, and locate the device generating the interrupt and clear it.

It should be noted that more than one device can provide an interrupt on a channel, so it is up to the master to ensure that all devices on a channel are interrogated for an interrupt.

The interrupt inputs may be used as general-purpose inputs if the interrupt function is not required.

If unused, interrupt input(s) must be connected to  $V_{CC}$  through a pull-up resistor.

**Table 2. Control Register Read (Interrupt)<sup>(1)</sup>**

D7	D6	$\overline{\text{INT1}}$	$\overline{\text{INT0}}$	D3	D2	B1	B0	COMMAND
X	X	X	0	X	X	X	X	No interrupt on channel 0
			1					Interrupt on channel 0
X	X	0	X	X	X	X	X	No interrupt on channel 1
		1						Interrupt on channel 1
0	0	0	0	0	0	0	0	No channel selected; power-up/reset default state

(1) Two interrupts can be active at the same time.

## 10 Application and Implementation

### 10.1 Application Information

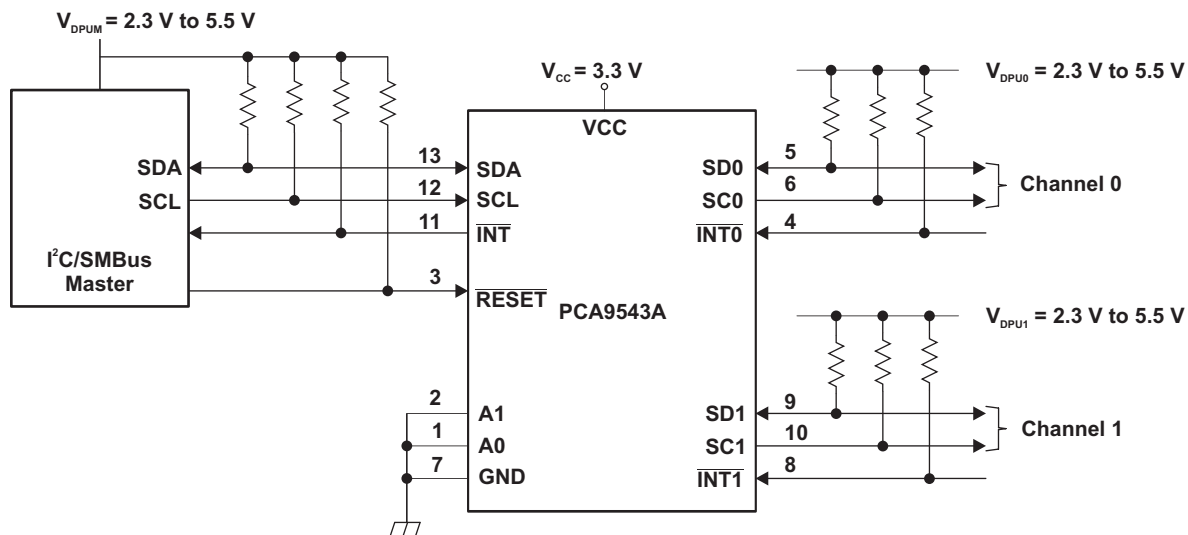
Applications of the PCA9543A will contain an I<sup>2</sup>C (or SMBus) master device and up to two I<sup>2</sup>C slave devices. The downstream channels are ideally used to resolve I<sup>2</sup>C slave address conflicts. For example, if two identical digital temperature sensors are needed in the application, one sensor can be connected at each channel: 0 and 1. When the temperature at a specific location needs to be read, the appropriate channel can be enabled and the other channel switched off, the data can be retrieved, and the I<sup>2</sup>C master can move on and read the next channel.

In an application where the I<sup>2</sup>C bus will contain many additional slave devices that do not result in I<sup>2</sup>C slave address conflicts, these slave devices can be connected to any desired channel to distribute the total bus capacitance across both channels. If both switches will be enabled simultaneously, additional design requirements must be considered (See [Design Requirements](#) and [Detailed Design Procedure](#)).

### 10.2 Typical Application

A typical application of the PCA9543A will contain anywhere from 1 to 3 separate data pull-up voltages,  $V_{DPUX}$ , one for the master device ( $V_{DPUM}$ ) and one for each of the selectable slave channels ( $V_{DPU0}$  and  $V_{DPU1}$ ). In the event where the master device and both slave devices operate at the same voltage, then the pass voltage,  $V_{pass} = V_{DPUX}$ . Once the maximum  $V_{pass}$  is known,  $V_{CC}$  can be selected easily using [Figure 13](#). In an application where voltage translation is necessary, additional design requirements must be considered (See [Design Requirements](#)).

[Figure 12](#) shows an application in which the PCA9543A can be used.



**Figure 12. Typical Application**

## Typical Application (continued)

### 10.2.1 Design Requirements

The pull-up resistors on the  $\overline{\text{INT1}}$ - $\overline{\text{INT0}}$  pins in the application schematic are not required in all applications. If the device generating the interrupt has an open-drain output structure or can be tri-stated, a pull-up resistor is required. If the device generating the interrupt has a push-pull output structure and cannot be tri-stated, a pull-up resistor is not required. The interrupt inputs should not be left floating in the application.

The A0 and A1 pins are hardware selectable to control the slave address of the PCA9543A. These pins may be tied directly to GND or  $V_{CC}$  in the application.

If both slave channels will be activated simultaneously in the application, then the total  $I_{OL}$  from SCL/SDA to GND on the master side will be the sum of the currents through all pull-up resistors,  $R_p$ .

The pass-gate transistors of the PCA9543A are constructed such that the  $V_{CC}$  voltage can be used to limit the maximum voltage that is passed from one I<sup>2</sup>C bus to another.

Figure 13 shows the voltage characteristics of the pass-gate transistors (note that the graph was generated using data specified in the [Electrical Characteristics](#) section of this data sheet). In order for the PCA9543A to act as a voltage translator, the  $V_{pass}$  voltage must be equal to or lower than the lowest bus voltage. For example, if the main bus is running at 5 V and the downstream buses are 3.3 V and 2.7 V,  $V_{pass}$  must be equal to or below 2.7 V to effectively clamp the downstream bus voltages. As shown in Figure 13,  $V_{pass(max)}$  is 2.7 V when the PCA9543A supply voltage is 4 V or lower, so the PCA9543A supply voltage could be set to 3.3 V. Pull-up resistors then can be used to bring the bus voltages to their appropriate levels (see Figure 12).

### 10.2.2 Detailed Design Procedure

Once all the slaves are assigned to the appropriate slave channels and bus voltages are identified, the pull-up resistors,  $R_p$ , for each of the buses need to be selected appropriately. The minimum pull-up resistance is a function of  $V_{DPUX}$ ,  $V_{OL(max)}$ , and  $I_{OL}$ :

$$R_{p(min)} = \frac{V_{DPUX} - V_{OL(max)}}{I_{OL}} \quad (1)$$

The maximum pull-up resistance is a function of the maximum rise time,  $t_r$  (300 ns for fast-mode operation,  $f_{SCL} = 400$  kHz) and bus capacitance,  $C_b$ :

$$R_{p(max)} = \frac{t_r}{0.8473 \times C_b} \quad (2)$$

The maximum bus capacitance for an I<sup>2</sup>C bus must not exceed 400 pF for fast-mode operation. The bus capacitance can be approximated by adding the capacitance of the PCA9543A,  $C_{i0(OFF)}$ , the capacitance of wires/connections/traces, and the capacitance of each individual slave on a given channel. If both channels will be activated simultaneously, each of the slaves on both channels will contribute to total bus capacitance.

## Typical Application (continued)

### 10.2.3 PCA9543A Application Curves

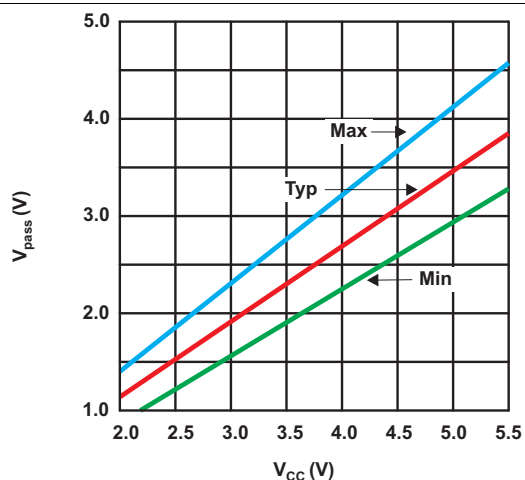


Figure 13. Pass-Gate Voltage ( $V_{pass}$ ) vs Supply Voltage ( $V_{CC}$ ) at Three Temperature Points

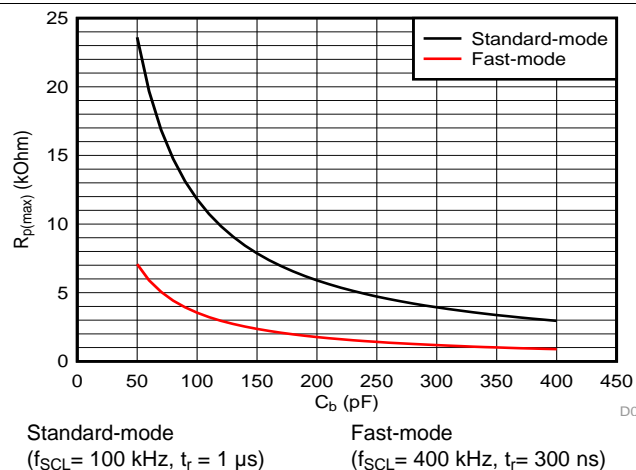


Figure 14. Maximum Pull-Up Resistance ( $R_{p(max)}$ ) vs Bus Capacitance ( $C_b$ )

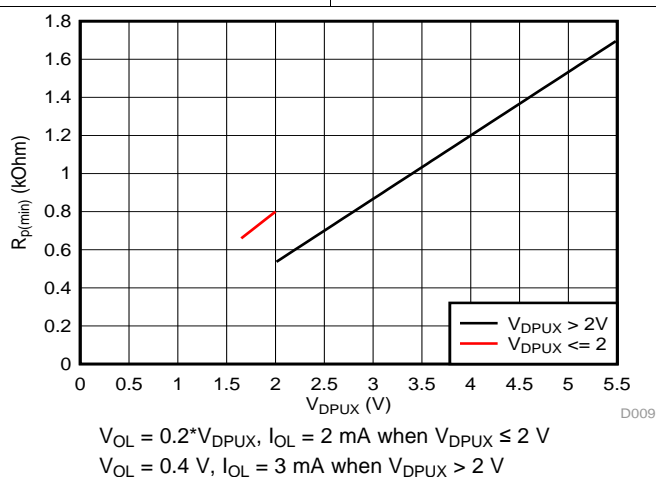


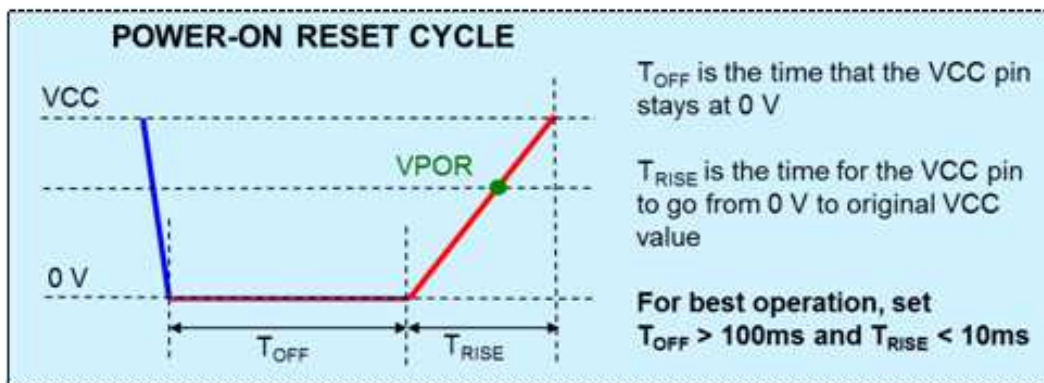
Figure 15. Minimum Pull-Up Resistance ( $R_{p(min)}$ ) vs Pull-Up Reference Voltage ( $V_{DPUX}$ )

## 11 Power Supply Recommendations

The operating power-supply voltage range of the PCA9543A is 2.3 V to 5.5 V applied at the VCC pin. When the PCA9543A is powered on for the first time or anytime the device needs to be reset by cycling the power supply, the power-on reset requirements must be followed to ensure the I<sup>2</sup>C bus logic is initialized properly.

### 11.1 Power-On Reset Errata

A power-on reset condition can be missed if the VCC ramps are outside specification listed below.



#### System Impact

If ramp conditions are outside timing allowances above, POR condition can be missed, causing the device to lock up.

## 12 Layout

### 12.1 Layout Guidelines

For PCB layout of the PCA9543A, common PCB layout practices should be followed but additional concerns related to high-speed data transfer such as matched impedances and differential pairs are not a concern for I<sup>2</sup>C signal speeds. It is common to have a dedicated ground plane on an inner layer of the board and pins that are connected to ground should have a low-impedance path to the ground plane in the form of wide polygon pours and multiple vias. By-pass and de-coupling capacitors are commonly used to control the voltage on the VCC pin, using a larger capacitor to provide additional power in the event of a short power supply glitch and a smaller capacitor to filter out high-frequency ripple.

In an application where voltage translation is not required, all  $V_{DPUX}$  voltages and  $V_{CC}$  could be at the same potential and a single copper plane can connect all of the pull-up resistors to the appropriate reference voltage. In an application where voltage translation is required,  $V_{DPU0}$ ,  $V_{DPU1}$ , and  $V_{DPU2}$ , may all be on the same layer of the board with split planes to isolate different voltage potentials.

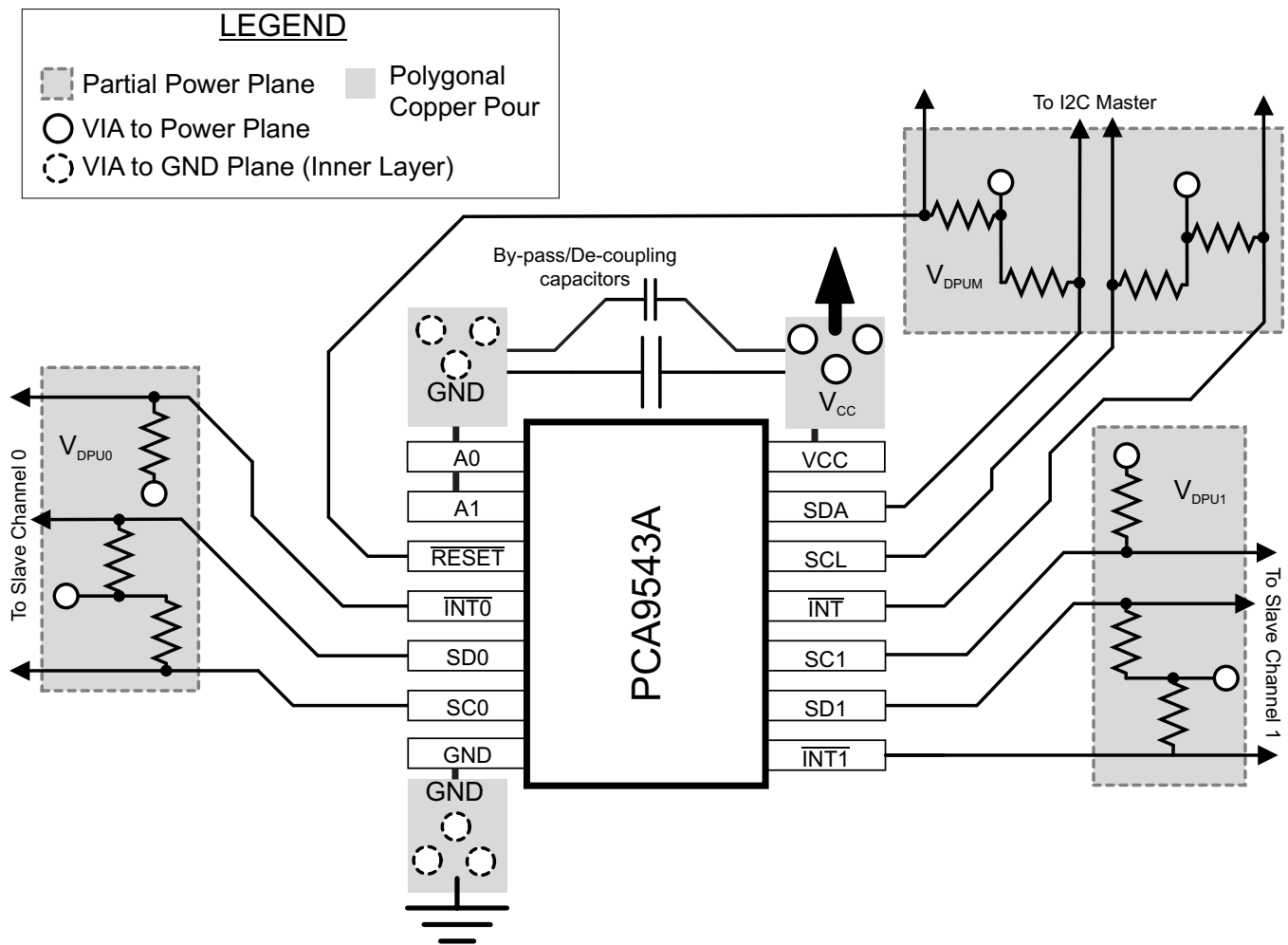
To reduce the total I<sup>2</sup>C bus capacitance added by PCB parasitics, data lines (SCn, SDn and  $\overline{\text{INTn}}$ ) should be as short as possible and the widths of the traces should also be minimized (e.g. 5-10 mils depending on copper weight).

## PCA9543A

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### 12.2 Layout Example



## 13 Device and Documentation Support

### 13.1 Trademarks

All trademarks are the property of their respective owners.

### 13.2 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 13.3 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
PCA9543AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PCA9543A	<a href="#">Samples</a>
PCA9543ADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PCA9543A	<a href="#">Samples</a>
PCA9543ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PCA9543A	<a href="#">Samples</a>
PCA9543APW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PD543A	<a href="#">Samples</a>
PCA9543APWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PD543A	<a href="#">Samples</a>
PCA9543APWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	PD543A	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

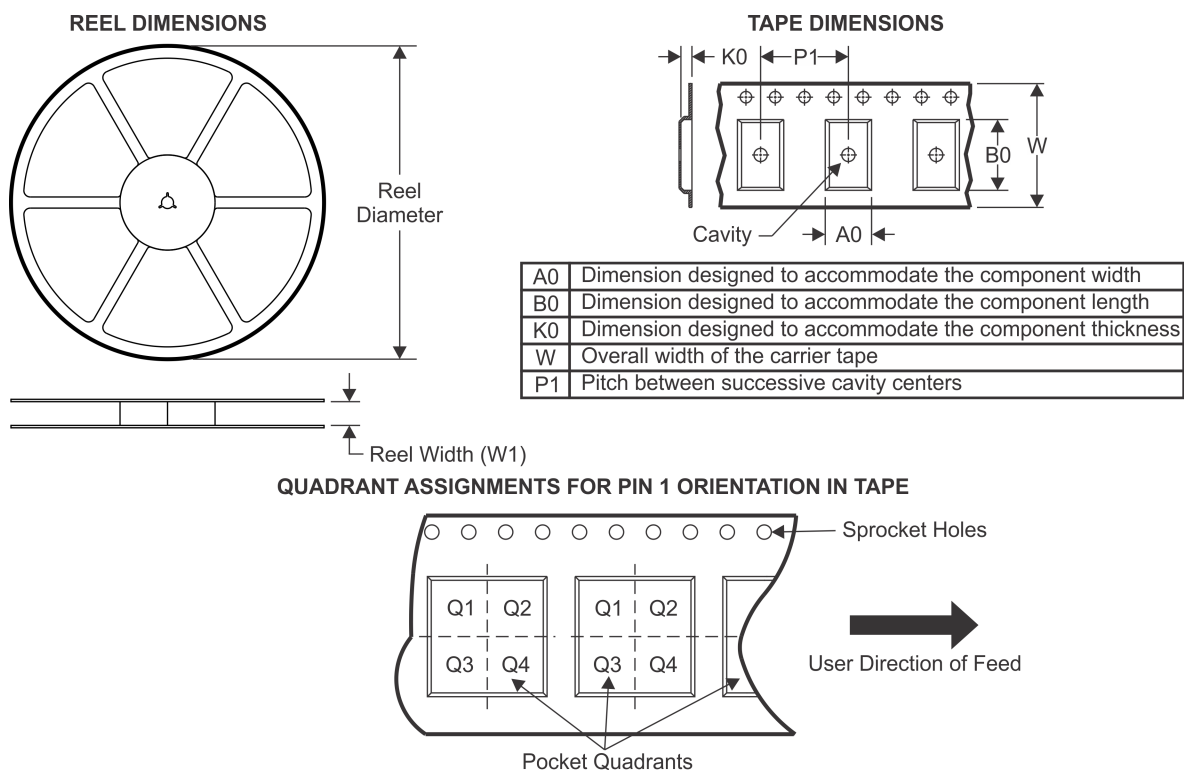
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

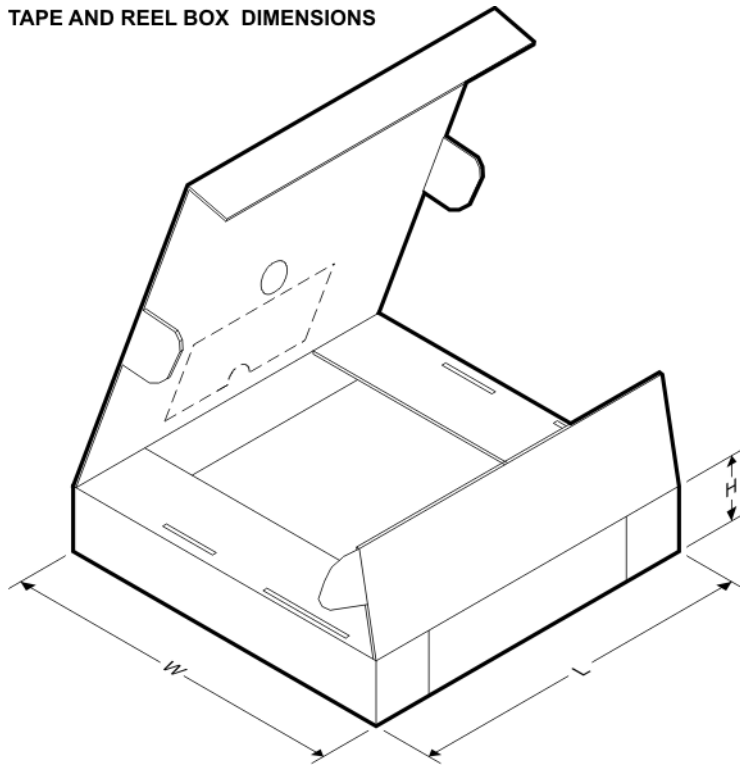
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
PCA9543ADR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
PCA9543APWR	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

## TAPE AND REEL BOX DIMENSIONS

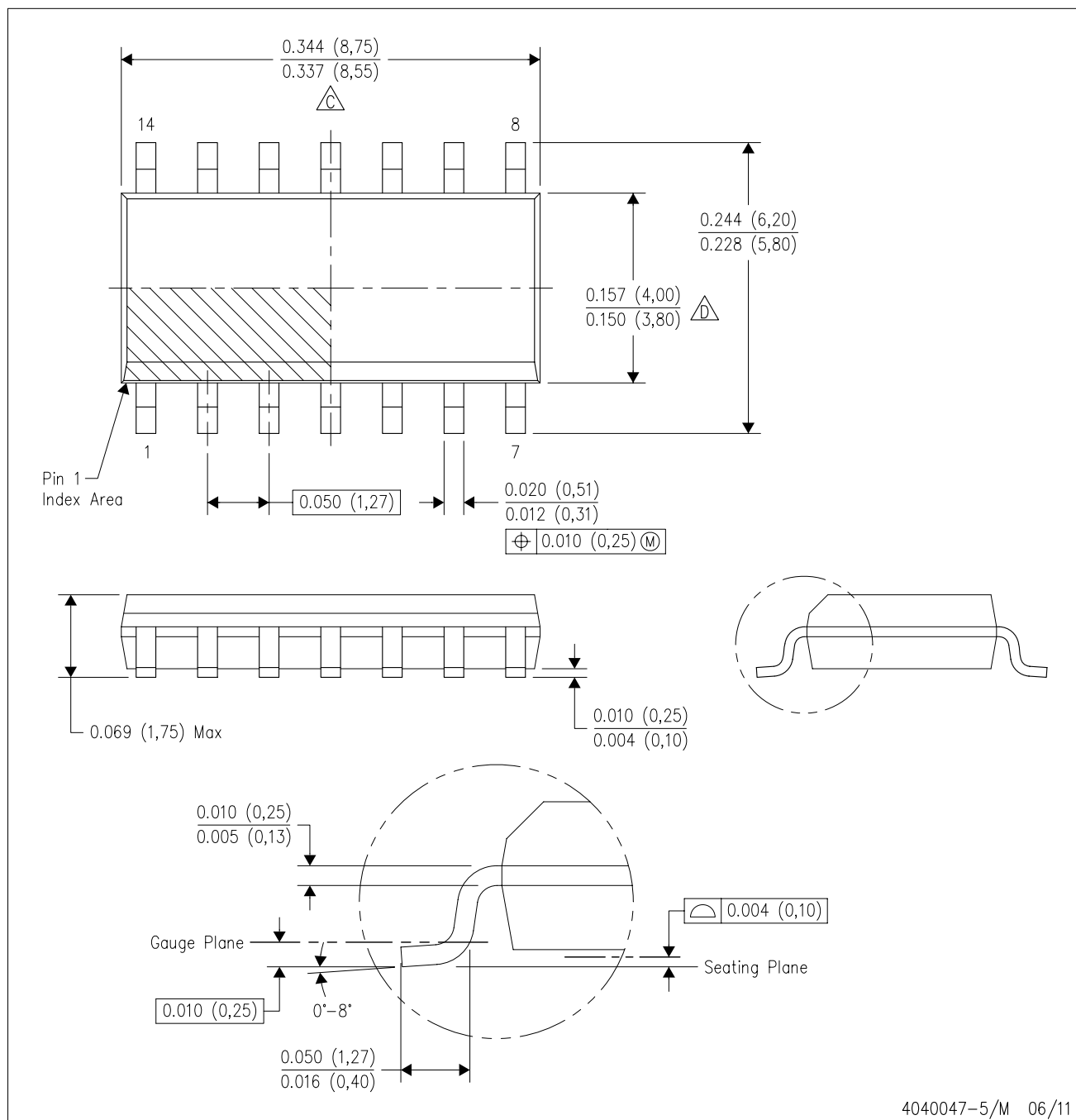


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
PCA9543ADR	SOIC	D	14	2500	367.0	367.0	38.0
PCA9543APWR	TSSOP	PW	14	2000	367.0	367.0	35.0

D (R-PDSO-G14)

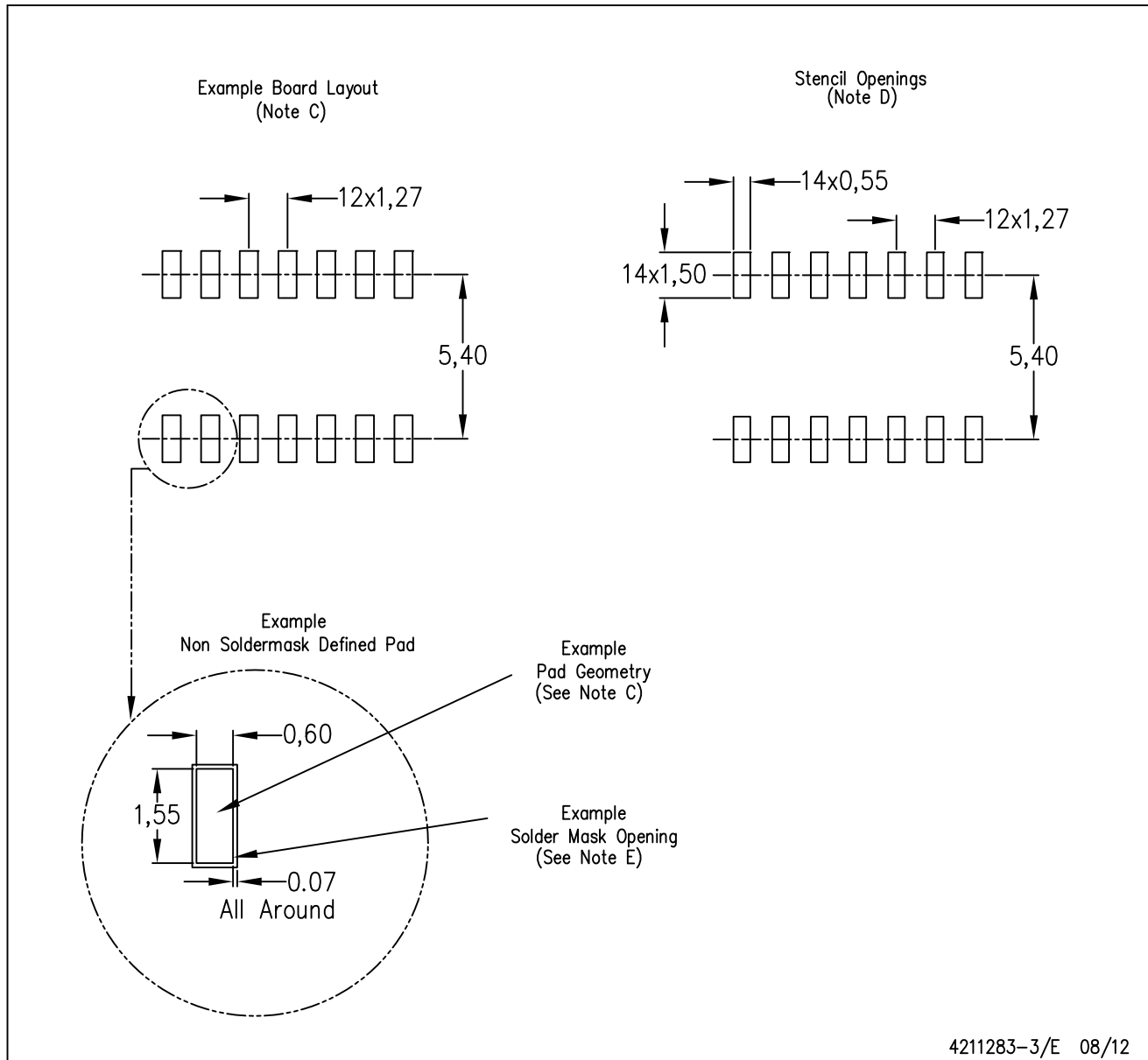
PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.  
 D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.  
 E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

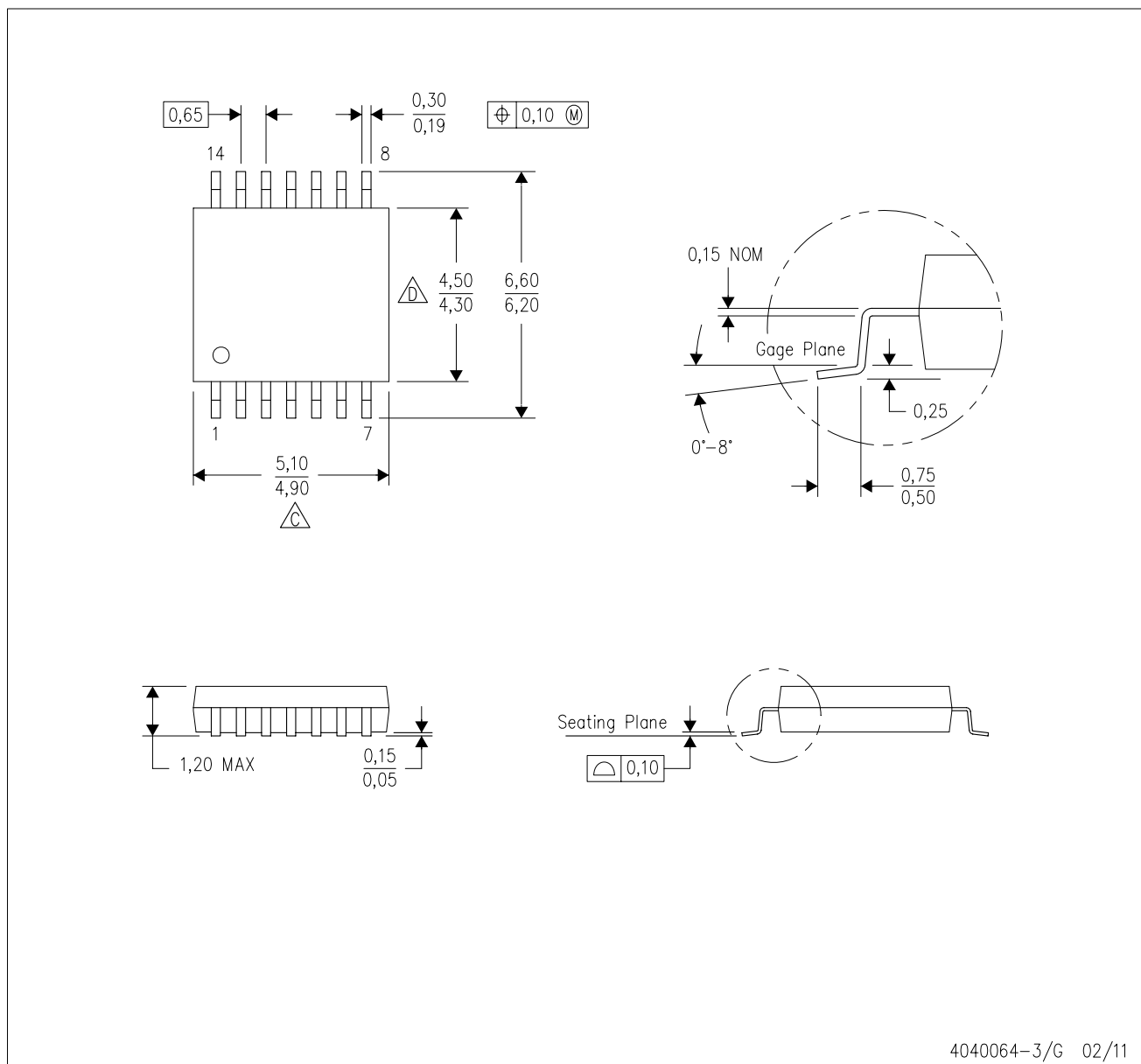
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE

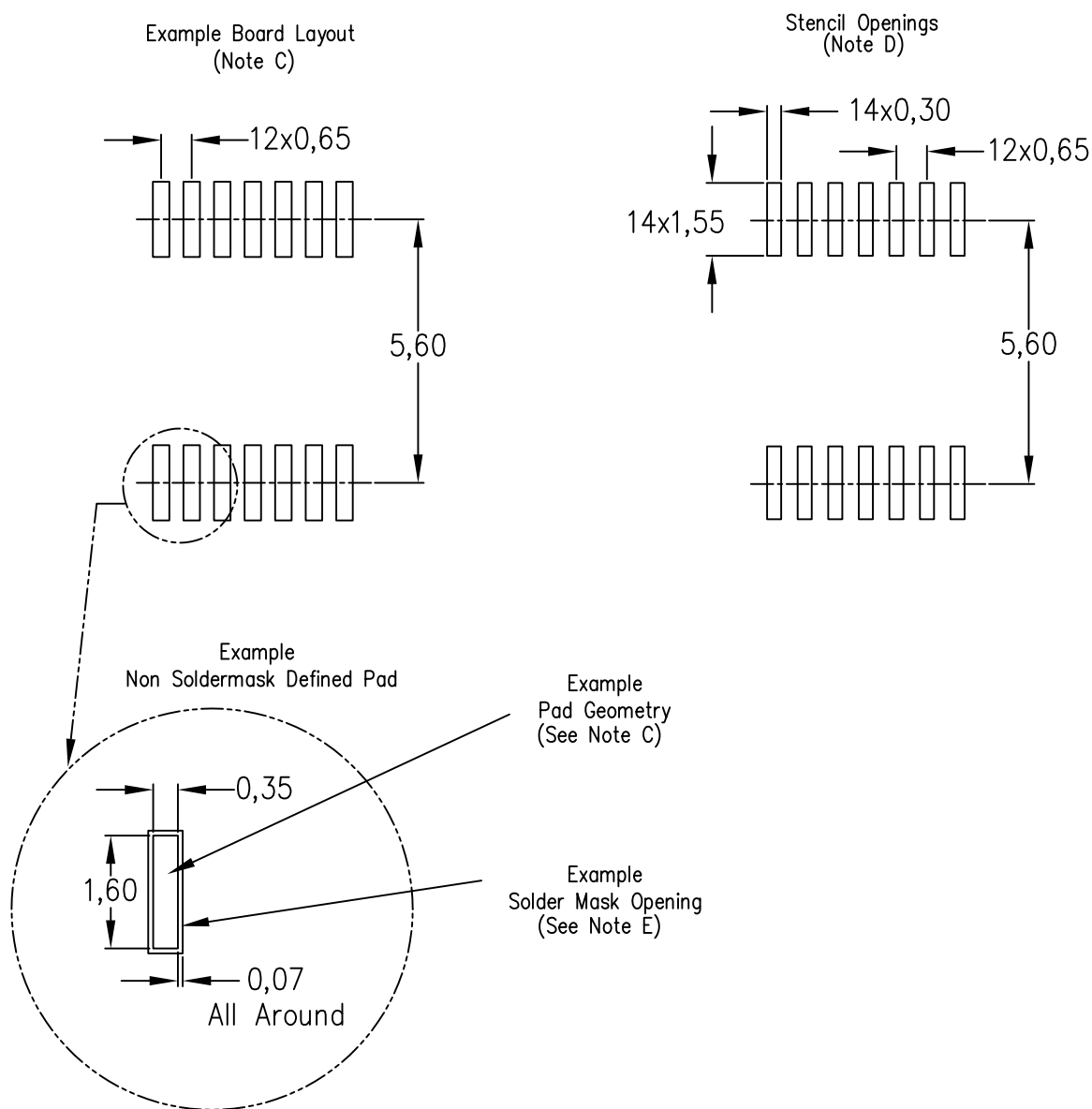


4040064-3/G 02/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



4211284-2/F 12/12

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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